



## SMTF30A 3000A Transient Voltage Suppressor

Rev.1.4

### DESCRIPTION:

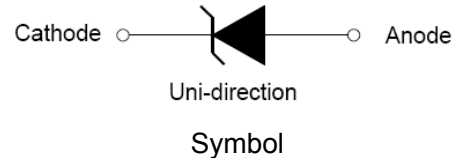
The SMTF30A TVS is specially designed for use in D.C. line protection and any demanding applications. They can offer superior clamping characteristics. Therefore, any voltage rise due to increased current conduction is contained to a minimum, providing the best possible protection level.

### FEATURES:

- ✧ Halogen-free.
- ✧ Uni-directional.
- ✧ RoHS compliant.
- ✧ Low slope resistance.
- ✧ Very low clamping voltage.
- ✧ Sharp breakdown voltage.
- ✧ Glass passivated junction.
- ✧ Plastic package has underwriters laboratory flammability 94V-0.
- ✧ High temperature reflow soldering: 260°C/40s at terminals.
- ✧ Meets MSL level 1, per J-STD-020, LF maximum peak of 260°C.
- ✧ Terminal: solder plated, solderable per J-STD-002.
- ✧ IEC61000-4-2 (ESD) ±30kV (air), ±30kV (contact).



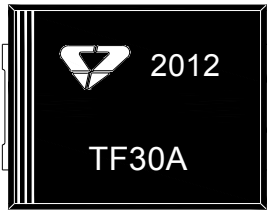
SMTF



### ABSOLUTE MAXIMUM RATINGS( $T_A=25^{\circ}\text{C}$ , RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak pulse current@8/20 $\mu\text{s}$ waveform	$I_{PP}$	3000	A
Operating junction temperature range	$T_J$	-55 to +150	$^{\circ}\text{C}$
Storage temperature range	$T_{STG}$	-55 to +150	$^{\circ}\text{C}$
Typical thermal resistance junction to lead	$R_{\theta JL}$	15	$^{\circ}\text{C}/\text{W}$
Typical thermal resistance junction to ambient	$R_{\theta JA}$	75	$^{\circ}\text{C}/\text{W}$

**MARKING**



TF30A: Device Marking Code  
2012: the 12th week, 2020

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub>=25°C)

Maximum V<sub>F</sub>=1.6V at I<sub>F</sub>=200mA

Part Number	Marking	V <sub>R</sub>	V <sub>BR@I<sub>T</sub></sub>		I <sub>T</sub>	I <sub>R@V<sub>R</sub></sub>	V <sub>C@3000A</sub> 8/20μs	
			Min(V)	Max(V)			Typ(V)	Max(V)
Uni-Polar	Uni	V			mA	Max(μA)		
SMTF30A	TF30A	30	33	37	10	5	50	55

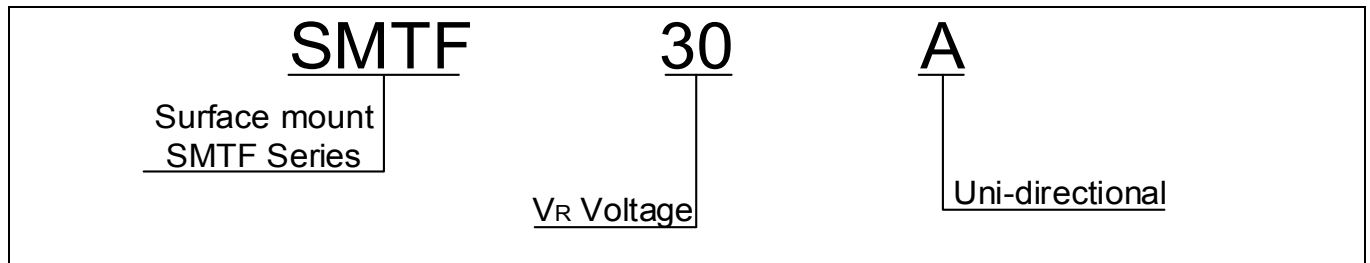
V<sub>R</sub>: Stand-off voltage -- Maximum voltage that can be applied

V<sub>BR</sub>: Breakdown voltage

V<sub>C</sub>: Clamping voltage -- Peak voltage measured across the suppressor at a specified I<sub>PP</sub>

I<sub>R</sub>: Reverse leakage current

**ORDERING INFORMATION**



RATINGS AND V-I CHARACTERISTICS CURVES (T<sub>A</sub>=25°C, unless otherwise noted)

FIG.1:V- I curve characteristics (Uni-directional)

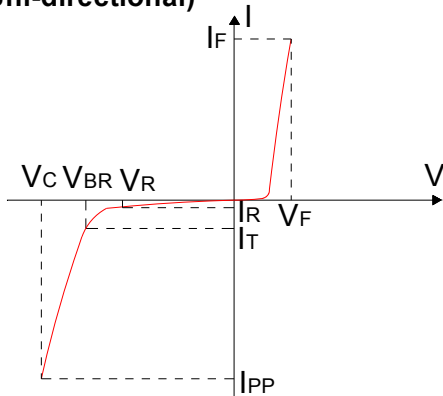


FIG.2: Typical V<sub>BR</sub> vs. junction temperature

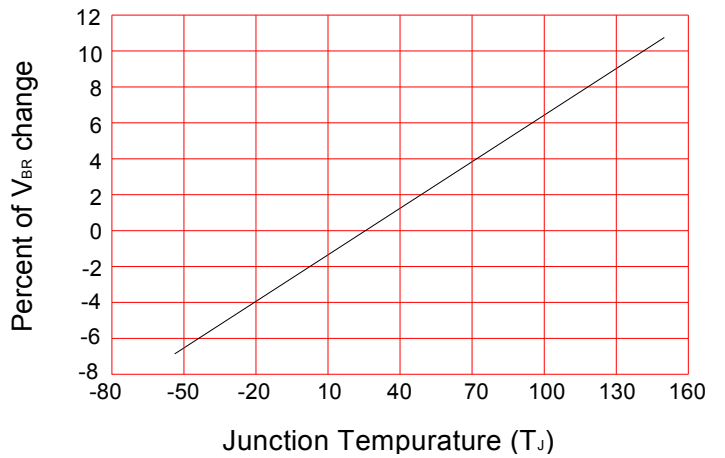


FIG.3: Pulse waveform

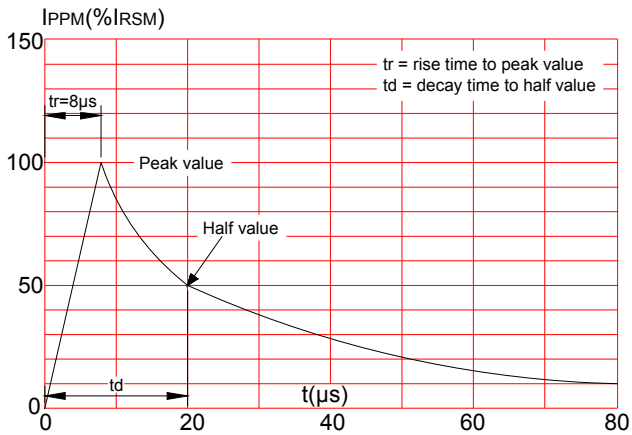


FIG.4: Pulse waveform

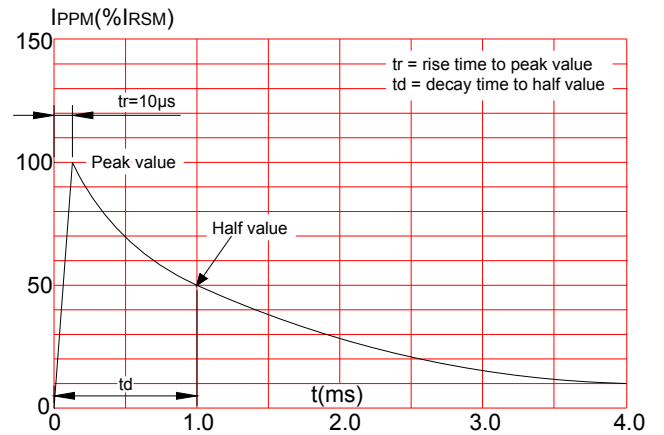


FIG.5: Pulse derating curve(8/20µs)

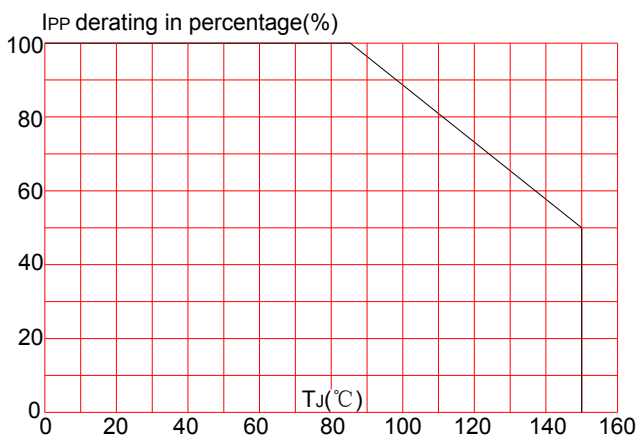
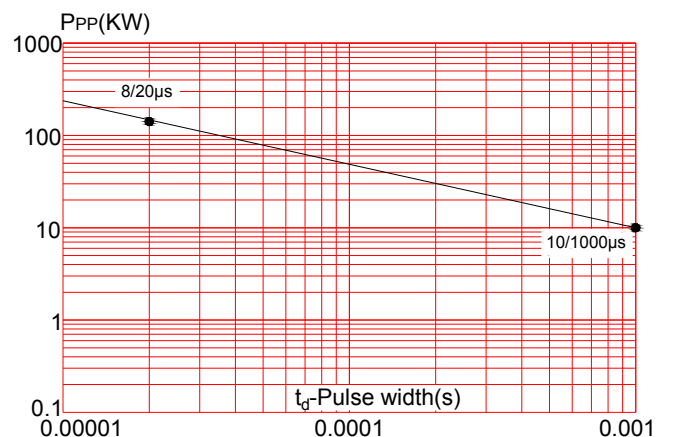
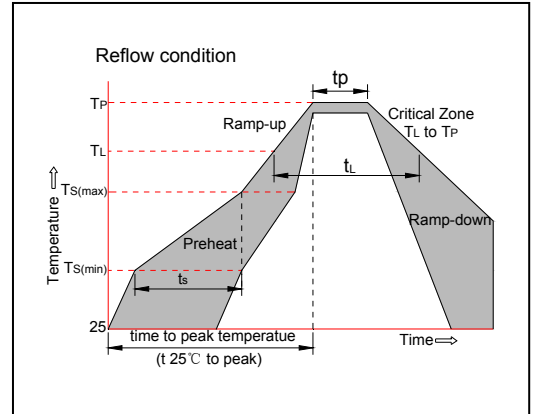


FIG.6: Typical peak pulse power rating curve

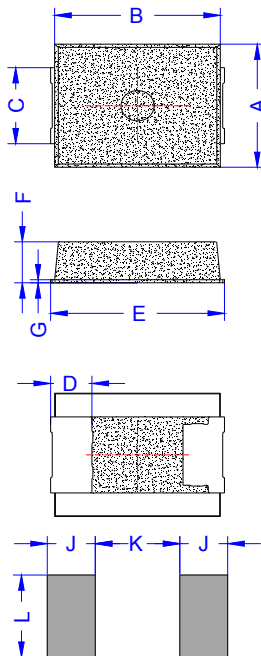


**SOLDERING PARAMETERS**

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquidus Temp ( $T_L$ )to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ )(Liquidus)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_p$ )		8 min. Max
Do not exceed		+260°C



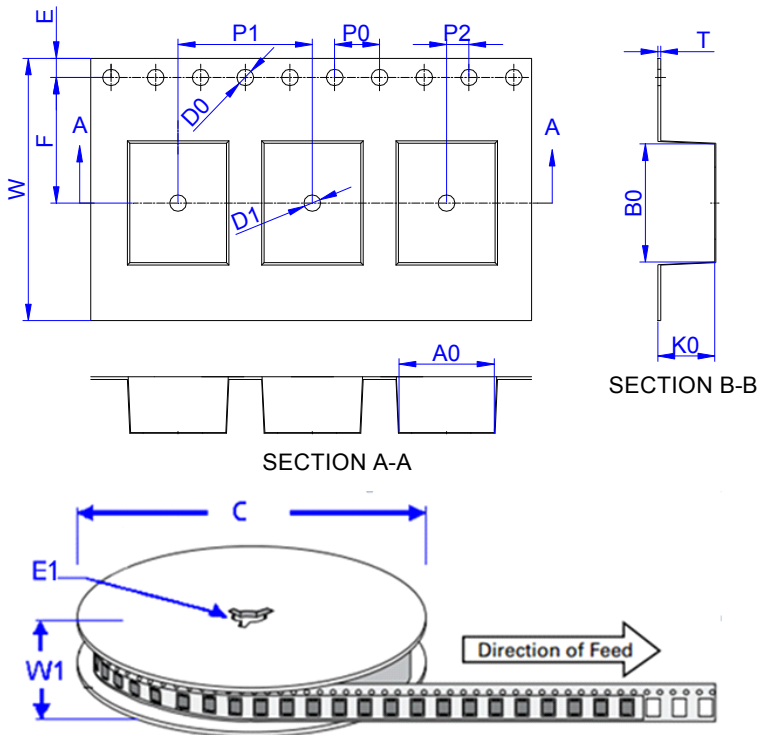
**PACKAGE MECHANICAL DATA**



**SMTF**

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	7.80	8.40	0.307	0.331
B	9.70	10.30	0.382	0.406
C	4.8	5.2	0.189	0.205
D	2.0		0.079	
E	10.30	10.70	0.406	0.421
F	2.60	2.80	0.102	0.110
G	0.12	0.28	0.005	0.011
J	2.80		0.110	
K		5.30		0.209
L	5.40		0.213	

**TAPE AND REEL SPECIFICATION-SMTF**



Ref.	Dimensions	
	Millimeters	Inches
A0	8.50±0.10	0.335±0.004
B0	10.80±0.10	0.425±0.004
C	330.0	13.0
D0	1.50±0.10	0.059±0.004
D1	1.50±0.10	0.059±0.004
E	1.75±0.10	0.069±0.004
E1	13.3±0.3	0.524±0.012
F	11.50±0.10	0.453±0.004
K0	5.10±0.10	0.201±0.004
P0	4.00±0.10	0.157±0.004
P1	12.00±0.10	0.472±0.004
P2	2.00±0.10	0.079±0.004
T	0.30±0.05	0.012±0.002
W	24.00±0.30	0.945±0.012
W1	28.5±2.0	1.122±0.079

PART No.	PACKAGE TYPE	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
SMTF30A	SMTF	1,500	12,000	13 inch reel pack

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